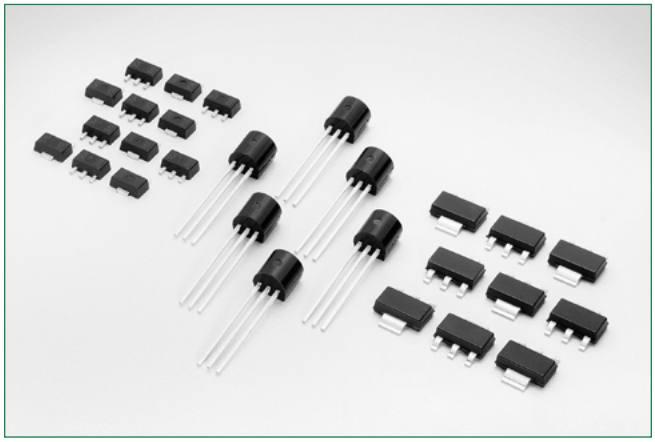
Sx02xSx EV Series

EV Series 1.5 Amp Sensitive SCRs

HF RoHS



Description

This new 1.5A sensitive gate SCR component series offers high static dv/dt and low turn-off time (tq) All SCR junctions are glass-passivated to ensure long term reliability and parametric stability.

Features

- Surge capability > 15Amps
- Blocking voltage (VDRM/ VRRM) capability — up to 600V
- High dv/dt noise immunity
- Improved turn-off time (tq) < 35 µsec.
- Sensitive gate for direct microprocessor interface
- Thru hole and surface mount packages
- RoHS compliant and Halogen-Free

Additional Information

Resources | Accessories | Samples

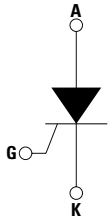
Applications

The Sx02xSx EV series is specifically designed for solenoid drive often seen in GFCI and similar safety cut-off devices.

Main Features

Symbol	Value	Unit
$I_{T(RMS)}$	1.5	A
V_{DRM}/V_{RRM}	400 or 600	V
I_{GT}	200	µA

Schematic Symbol



Absolute Maximum Ratings

Symbol	Parameter			Value	Unit
$I_{T(RMS)}$	RMS on-state current (full sine wave)	TO-92	T_C = 65°C	1.5	A
		SOT-89	T_C = 80°C		
		SOT-223	T_C = 95°C		
$I_{T(AV)}$	Average on-state current	TO-92	T_C = 65°C	0.95	A
		SOT-89	T_C = 80°C		
		SOT-223	T_C = 95°C		
I_{TSM}	Non repetitive surge peak on-state current (Single cycle, T_J initial = 25°C)	TO-92 SOT-89 SOT-223	F = 50 Hz	12.5	A
			F = 60 Hz	15.0	
I^2t	I^2t Value for fusing	t_p = 10 ms	F = 50 Hz	0.78	A^2s
		t_p = 8.3 ms	F = 60 Hz	0.93	
di/dt	Critical rate of rise of on-state current IG = 10mA	TO-92 SOT-89 SOT-223	T_J = 125°C	50	A/µs
I_{GM}	Peak gate current	t_p = 10 µs	T_J = 125°C	1.0	A
$P_{G(AV)}$	Average gate power dissipation		T_J = 125°C	0.1	W
T_{stg}	Storage junction temperature range			-40 to 150	°C
T_J	Operating junction temperature range			-40 to 125	°C

Revised: GD. 03/19/21

Sx02xSx EV Series
EV Series 1.5 Amp Sensitive SCRs

Electrical Characteristics (TJ = 25°C, unless otherwise specified)

Symbol	Description	Test Conditions	Sx02xS		Sx02xS1		Sx02xS2		Units
			Min	Max	Min	Max	Min	Max	
I_{GT}	DC Gate Trigger Current	V_D = 12V; R_L = 60 Ω	15	200	15	100	15	50	µA
V_{GT}	DC Gate Trigger Voltage	V_D = 12V; R_L = 60 Ω	—	0.8	—	0.8	—	0.8	V
V_{GRM}	Peak Reverse Gate Voltage	I_{RG} = 10µA	5	—	5	—	5	—	V
I_H	Holding Current	R_{GK} = 1 kΩ	—	5	—	3	—	3	mA
(dv/dt)s	"Critical Rate-of-Rise of Off-State Voltage"	"T_J = 125°C $V_D = V_{DRM} / V_{RRM}$ Exponential Waveform R_{GK} = 1 kΩ"	25	—	25	—	25	—	V/µs
t_q	Turn-Off Time	"TJ = 125°C @ 600 V R_{GK} = 1 kΩ"	—	35	—	35	—	35	µs
t_{gt}	Turn-On Time	"I_G = 10mA PW = 15µsec I_T = 3.0A (pk)"	—	3	—	3	—	3	µs
V_{GD}	Gate Non-Trigger Voltage	"$V_D=V_{DRM}$, T_J=125°C, R_L=3.3KΩ"	0.2	—	0.2	—	0.2	—	V

x0 = voltage/10

Static Characteristics (TJ = 25°C, unless otherwise specified)

Symbol	Description	Test Conditions	Value		Unit
			Min	Max	
V_{TM}	Peak On-State Voltage	I_{TM} = 3.0A (pk)	—	1.70	V
I_{DRM}	Off-State Current, Peak Repetitive	T_J = 25°C @ $V_D = V_{DRM}$ R_{GK} = 1 kΩ	—	5	µA
		T_J = 125°C @ $V_D = V_{DRM}$ R_{GK} = 1 kΩ	—	500	µA

Thermal Resistances

Symbol	Parameter			Value	Unit
$R_{\Theta(J-C)}$	Junction to case (AC)	I_T = 1.5A $_{(RMS)}$[1]	TO-92	50	°C/W
			SOT-89	35	
			SOT-223	25	
$R_{\Theta(J-A)}$	Junction to ambient	I_T = 1.5A $_{(RMS)}$[1]	TO-92	160	°C/W
			SOT-89	90	
			SOT-223	60	

[1] 60Hz AC resistive load condition, 100% conduction.

Revised: GD. 03/19/21

Sx02xSx EV Series
EV Series 1.5 Amp Sensitive SCRs

Figure 1: Normalized DC Gate Trigger Current vs. Junction Temperature

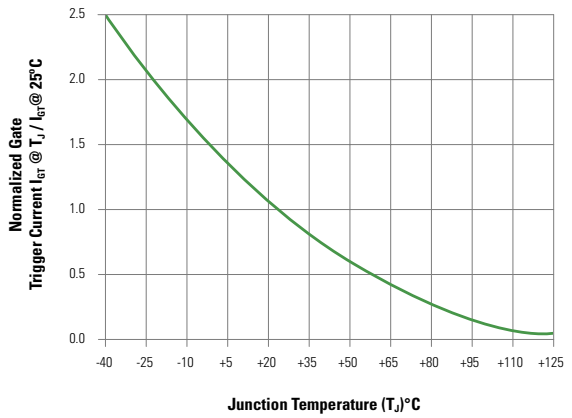


Figure 2: Normalized DC Holding Current vs. Junction Temperature

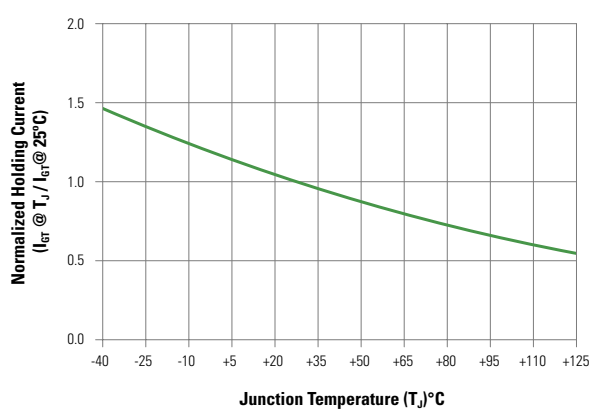


Figure 3: Normalized DC Gate Trigger Voltage vs. Junction Temperature

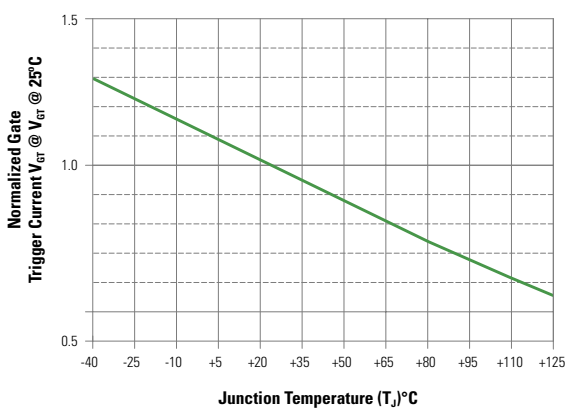


Figure 4: On-State Current vs. On-State Voltage (Typical)

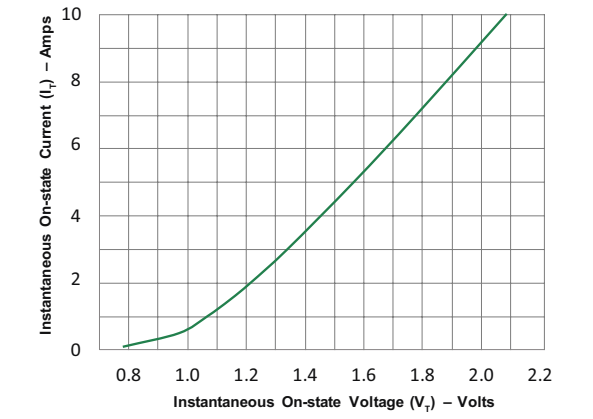


Figure 5: Power Dissipation (Typical) vs. RMS On-State Current

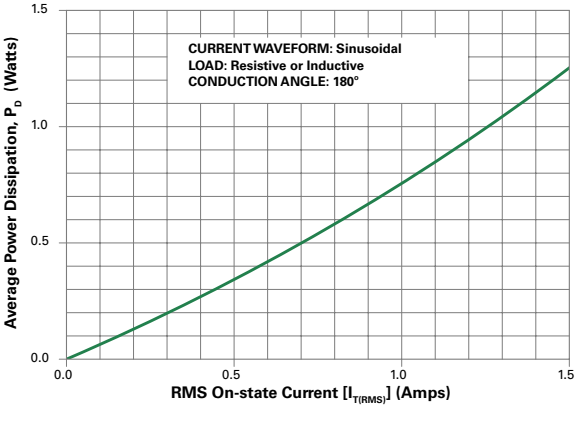
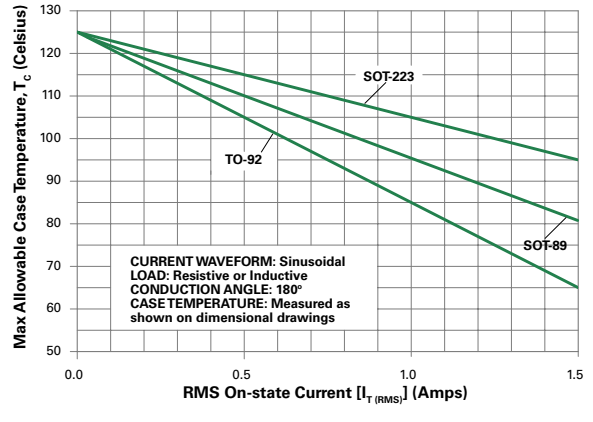


Figure 6: Maximum Allowable Case Temperature vs. On-State Current



Revised: GD. 03/19/21

Sx02xSx EV Series
EV Series 1.5 Amp Sensitive SCRs

Figure 7: Typical DC Gate Trigger Current with R_{GK} vs. Junction Temperature for Sx02xS

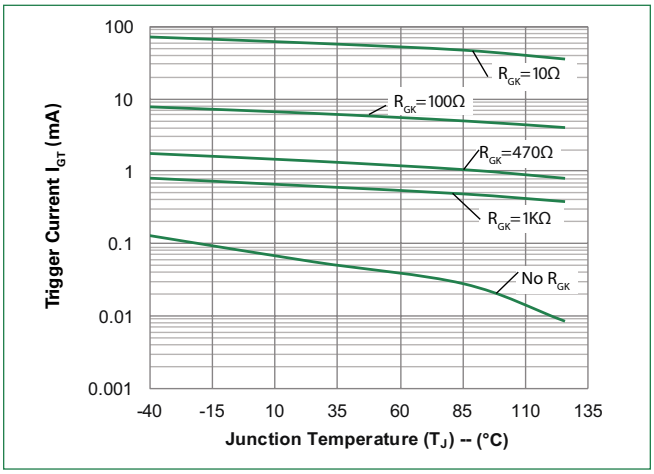


Figure 8: Typical DC Holding Current with R_{GK} vs. Junction Temperature for Sx02xS

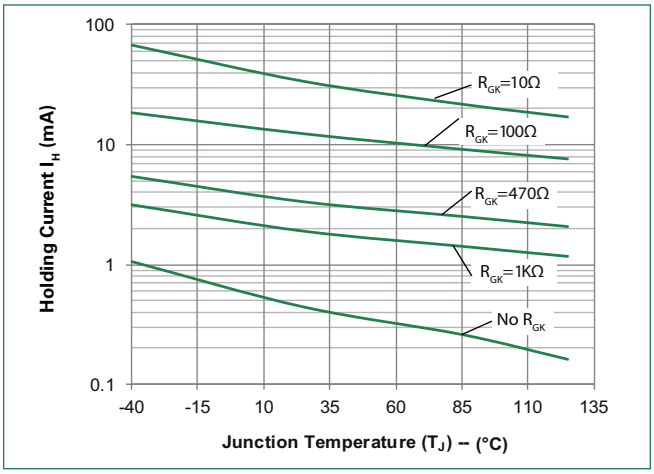


Figure 9: Typical Static dv/dt with R_{GK} vs. Junction Temperature for Sx02xS

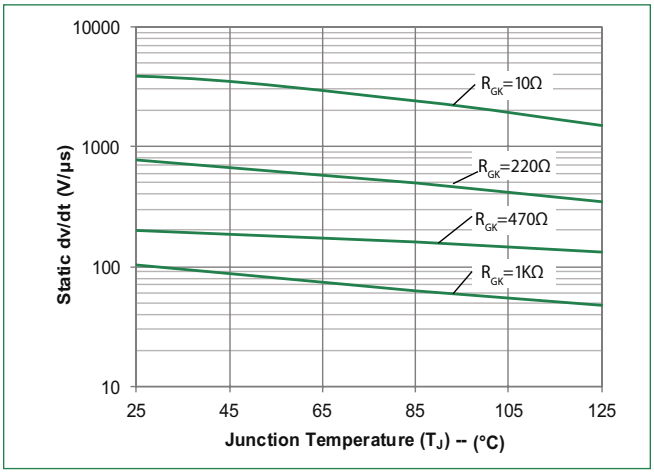


Figure 10: Typical turn off time with R_{GK} vs. Junction Temperature for Sx02xS

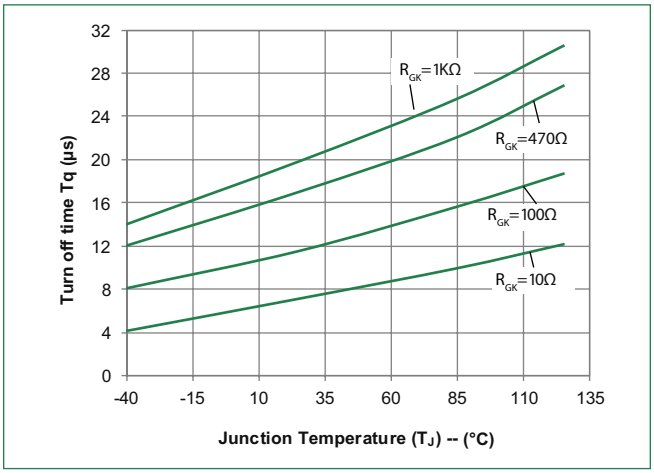
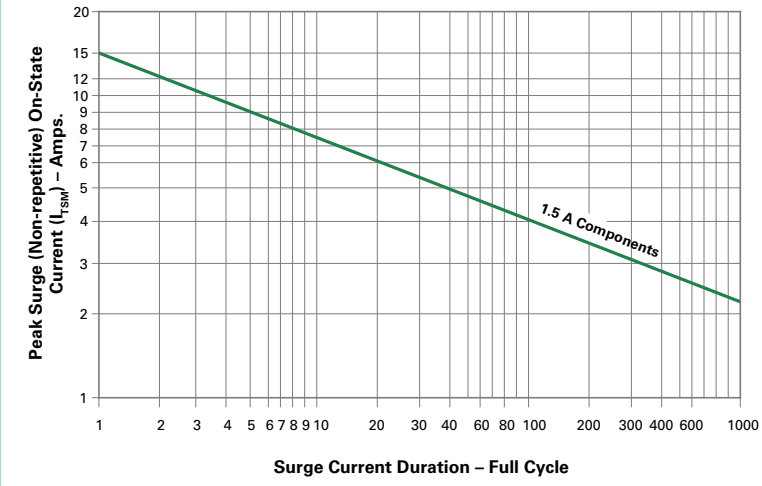


Figure 11: Surge Peak On-State Current vs. Number of Cycles



Supply Frequency: 60Hz Sinusoidal
Load: Resistive
RMS On-State Current [$I_{T(RMS)}$]: Max Rated Value at Specific Case Temperature

Notes:
1. Gate control may be lost during and immediately following surge current interval.
2. Overload may not be repeated until junction temperature has returned to steady-state rated value.

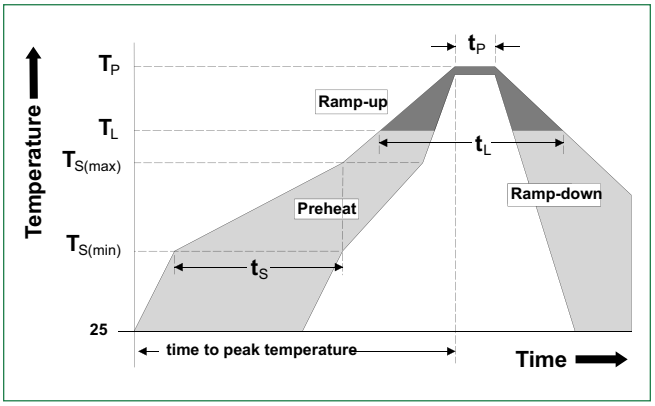
Revised: GD. 03/19/21

Sx02xSx EV Series

EV Series 1.5 Amp Sensitive SCRs

Soldering Parameters

Reflow Condition		Pb – Free assembly
Pre Heat	**- Temperature Min ($T_{s(min)}$)**	150°C
	- Temperature Max ($T_{s(max)}$)	200°C
	- Time (min to max) (t_s)	60 – 180 secs
Average ramp up rate (Liquidus Temp) (T_L) to peak		5°C/second max
$T_{S(max)}$ to T_L - Ramp-up Rate		5°C/second max
Reflow	**- Temperature (T_L) (Liquidus)**	217°C
	- Time (min to max) (t_s)	60 – 150 seconds
Peak Temperature (T_P)		$260^{+0/-5}$ °C
Time within 5°C of actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		5°C/second max
Time 25°C to peak Temperature (T_P)		8 minutes Max.
Do not exceed		280°C



Physical Specifications

Terminal Finish	100% Matte Tin-plated.
Body Material	UL Recognized compound meeting flammability rating V-0
Lead Material	Copper Alloy

Environmental Specifications

Test	Specifications and Conditions
AC Blocking	MIL-STD-750, M-1040, Cond A Applied Peak AC voltage @ 125°C for 1008 hours
Temperature Cycling	MIL-STD-750, M-1051, 100 cycles; -40°C to +150°C; 15-min dwell-time
Temperature/ Humidity	EIA / JEDEC, JESD22-A101 1008 hours; 160V - DC: 85°C; 85% rel humidity
Resistance to Solder Heat	MIL-STD-750 Method 2031
Solderability	ANSI/J-STD-002, category 3, Test A
Lead Bend	MIL-STD-750, M-2036 Cond E

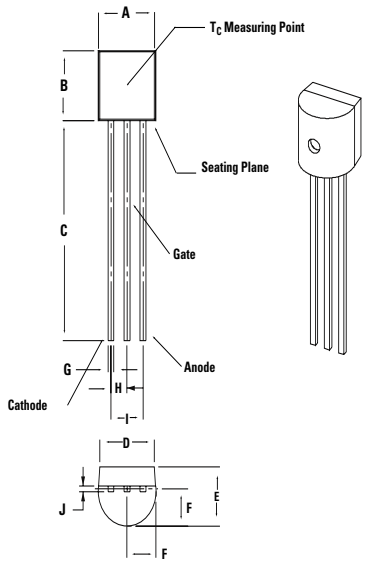
Design Considerations

Careful selection of the correct component for the application's operating parameters and environment will go a long way toward extending the operating life of the Thyristor. Good design practice should limit the maximum continuous current through the main terminals to 75% of the component rating. Other ways to ensure long life for a power discrete semiconductor are proper heat sinking and selection of voltage ratings for worst case conditions. Overheating, overvoltage (including dv/dt), and surge currents are the main killers of semiconductors. Correct mounting, soldering, and forming of the leads also help protect against component damage.

Sx02xSx EV Series

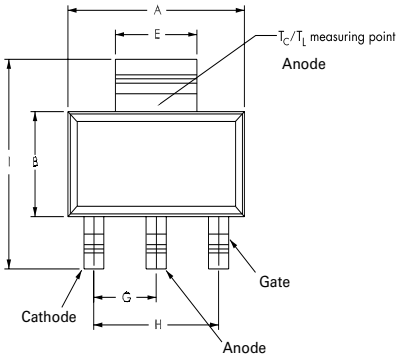
EV Series 1.5 Amp Sensitive SCRs

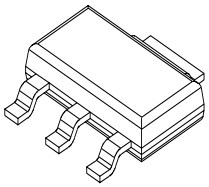
Dimensions — TO-92 (E Package)

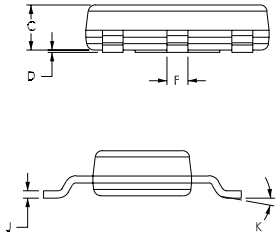


Dimensions	Inches		Millimeters	
	Min	Max	Min	Max
A	0.175	0.205	4.450	5.200
B	0.170	0.210	4.320	5.330
C	0.500	—	12.700	—
D	0.135	—	3.430	—
E	0.125	0.165	3.180	4.190
F	0.080	0.105	2.040	2.660
G	0.016	0.021	0.407	0.533
H	0.045	0.055	1.150	1.390
I	0.095	0.105	2.420	2.660
J	0.015	0.020	0.380	0.500

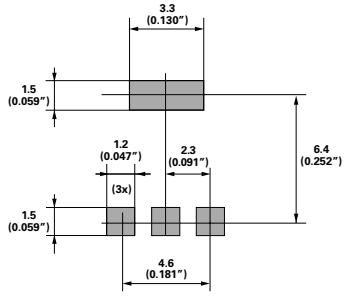
Dimensions – SOT-223







Pad Layout for SOT-223



Dimensions in Millimeters (Inches)

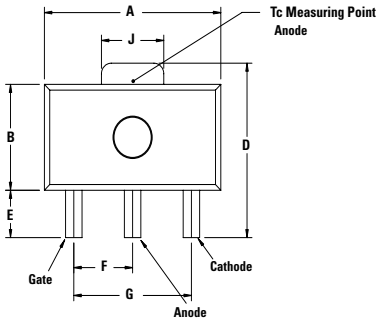
Dimensions	Inches			Millimeters		
	Min	Typ	Max	Min	Typ	Max
A	0.248	0.256	0.264	6.30	6.50	6.70
B	0.130	0.138	0.146	3.30	3.50	3.70
C	—	—	0.071	—	—	1.80
D	0.001	—	0.004	0.02	—	0.10
E	0.114	0.118	0.124	2.90	3.00	3.15
F	0.024	0.027	0.034	0.60	0.70	0.85
G	—	0.090	—	—	2.30	—
H	—	0.181	—	—	4.60	—
I	0.264	0.276	0.287	6.70	7.00	7.30
J	0.009	0.010	0.014	0.24	0.26	0.35
K	10° MAX					

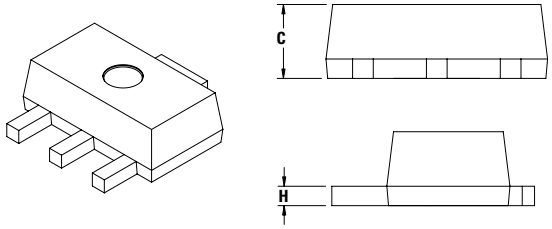
Revised: GD. 03/19/21

Sx02xSx EV Series

EV Series 1.5 Amp Sensitive SCRs

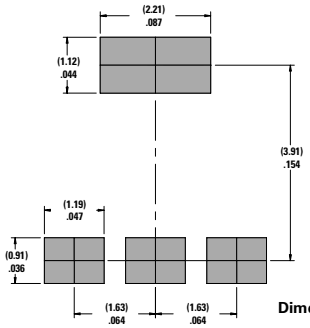
Dimensions – SOT-89





Dimension	Inches			Millimeters		
	Min	Typ	Max	Min	Typ	Max
A	0.173	—	0.181	4.40	—	4.60
B	0.090	—	0.102	2.29	—	2.60
C	0.055	—	0.063	1.40	—	1.60
D	0.155	—	0.167	3.94	—	4.25
E	0.035	—	0.047	0.89	—	1.20
F	0.056	—	0.062	1.42	—	1.57
G	0.115	—	0.121	2.92	—	3.07
H	0.014	—	0.017	0.35	—	0.44
I	0.014	—	0.019	0.36	—	0.48
J	0.064	—	0.072	1.62	—	1.83

Pad Layout for SOT-89



Dimensions in Millimeters (Inches)

Product Selector

Part Numbr	Voltage		Gate Sensitivity	Package
	400V	600V		
Sx02BS	X	X	200 µA	SOT-89
Sx02ES	X	X	200 µA	TO-92
Sx02TS	X	X	200 µA	SOT-223
Sx02BS1	X	X	100 µA	SOT-89
Sx02ES1	X	X	100 µA	TO-92
Sx02TS1	X	X	100 µA	SOT-223
Sx02BS2	—	X	50 µA	SOT-89

Note: x = voltage/100

Packing Options

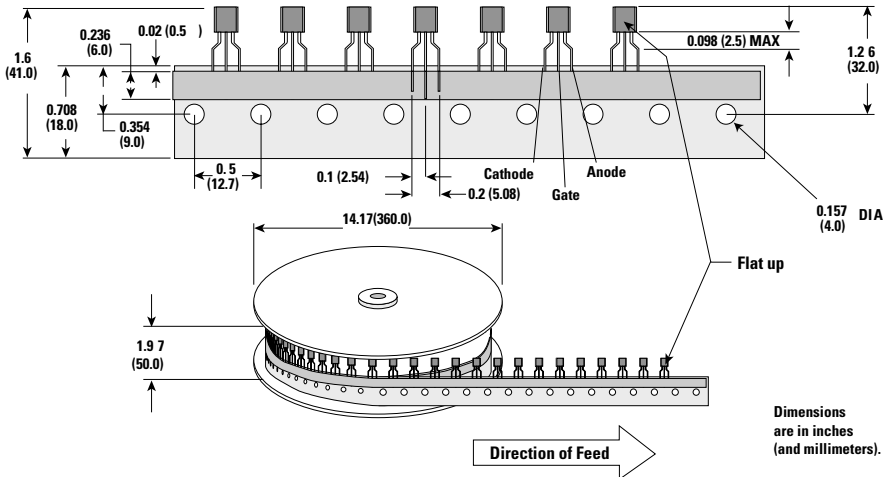
Part Number	Marking	Weight	Packing Mode	Base Quantity
Sx02ESy	Sx02ESy	0.217 g	Bulk	2500
Sx02ESyAP	Sx02ESy	0.217 g	Ammo Pack	2000
Sx02ESyRP	Sx02ESy	0.217 g	Tape & Reel	2000
Sx02TSyRP	Sx02TSy	0.120 g	Tape & Reel	1000
Sx02BSyRP	x02y	0.053 g	Tape & Reel	1000
Sx02BSyRP1	x02y	0.053 g	Tape & Reel	1000

Sx02xSx EV Series

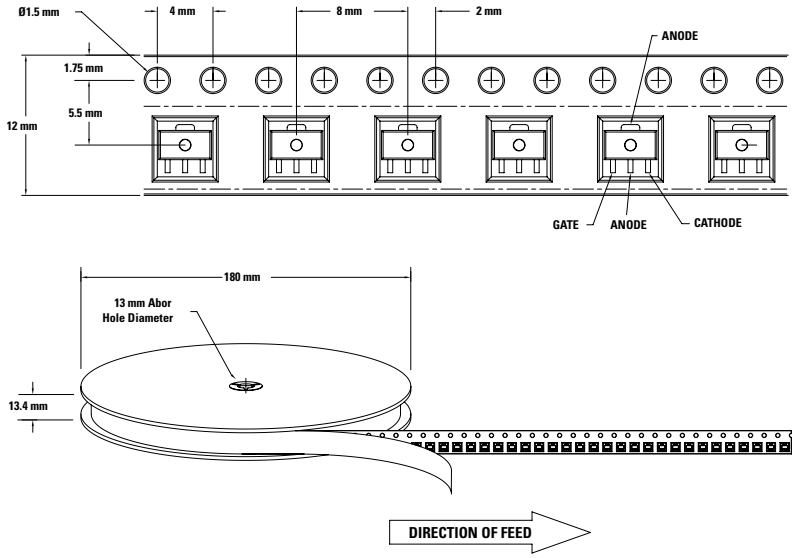
EV Series 1.5 Amp Sensitive SCRs

TO-92 (3-lead) Reel Pack (RP) Radial Leaded Specifications

Meets all EIA-468-C Standards



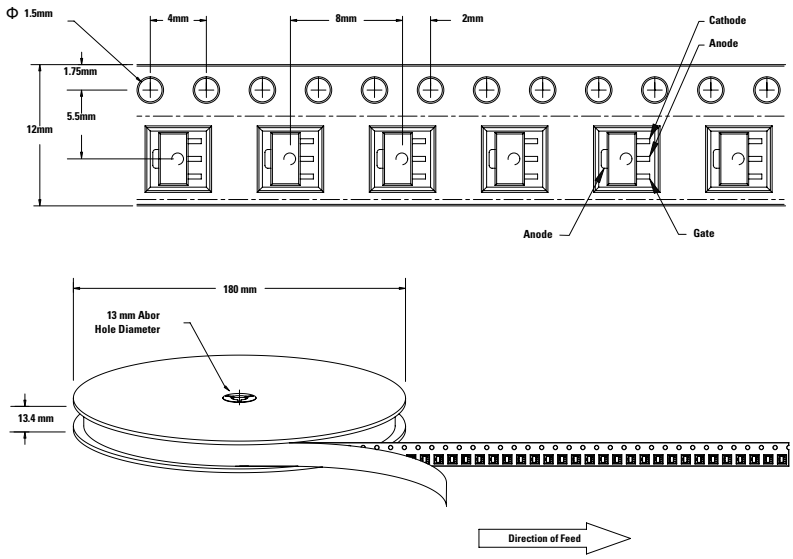
SOT-89 Reel Pack (RP) Specifications



Sx02xSx EV Series

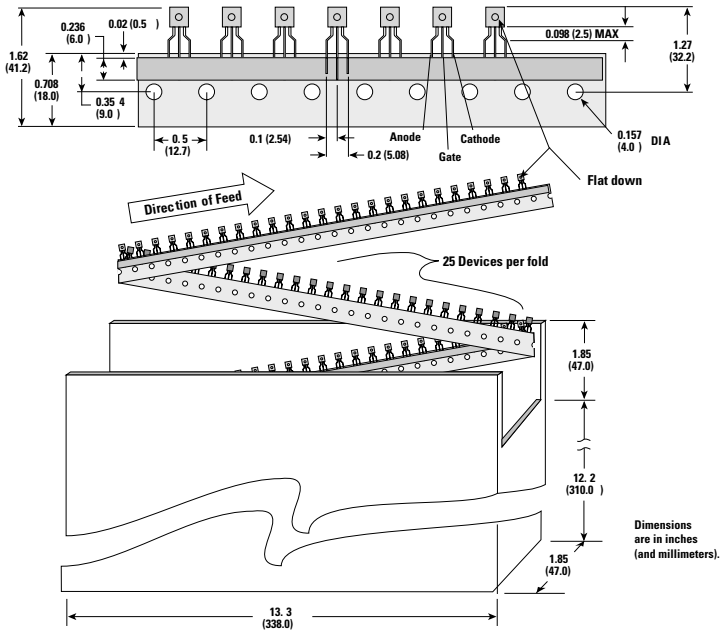
EV Series 1.5 Amp Sensitive SCRs

SOT-89 Reel Pack (RP1) Specifications



TO-92 (3-lead) Ammo Pack (AP) Radial Leaded Specifications

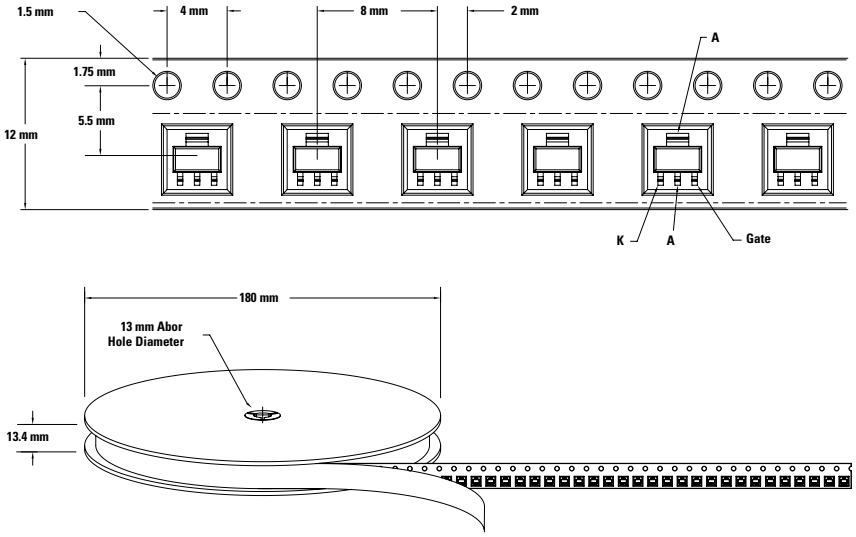
Meets all EIA-468-C Standards



Sx02xSx EV Series

EV Series 1.5 Amp Sensitive SCRs

SOT-223 Reel Pack (RP) Specifications



Part Numbering System

S x 02 x xx xx

SCR Series

Voltage
4: 400V
6: 600V

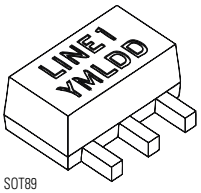
Current
02: 1.5A

Sensitivity
S: 200µA Sensitive SCR
S1: 100µA Sensitive SCR
S2: 50µA Sensitive SCR

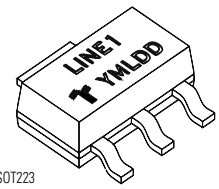
Package Type
E: TO-92
T: SOT-223
B: SOT-89

Packing Type
Blank: Bulk
RP: Reel Pack (TO-92)
: Embossed Carrier Pack (SOT-223)
AP: Ammo Pack (TO-92)

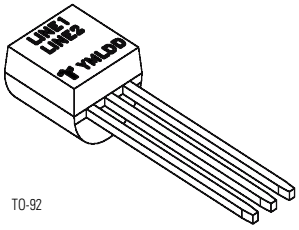
Part Marking System



SOT89



SOT223



TO-92

Line1 = Littelfuse Part Number
Line2 = continuation…Littelfuse Part Number
Y = Last Digit of Calendar Year
M = Letter Month Code (A-L for Jan-Dec)
L = Location Code
DD = Calendar Date

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